FORMAT STYLE TEMPLATE AND GUIDELINES  
FOR MANUSCRIPT PREPARATION

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1The Technical Manuscript Design Group, CHINA and

2The Scientific Paper Formatting Initiative, JAPAN

Abstract

The manuscript should start with a brief abstract of approximately 100 words summarizing the main goals, developments, and achievements of the work. Consider that the abstract may be included in abstract search databases. Think of what requirements the abstract should fulfill in view of this perspective.

KEYWORDS

A few meaningful keywords describing the essential topics of the paper.

Introduction

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**

Figure 1: Reflections on corrugated liquid/gas interface, with obstacles, observed by Monet. Rendering with 300 dpi.

****

Poor contrast and small labeling

Figure 2: Reflection on life, originally shaped by Rodin: rendering with low resolution (75 dpi), unfavorable size, and other deficiencies.

Tables should span one column and should be preceded by a caption. Table 1 illustrates a possible design. Design details are left to the authors. If a table or figure is too wide to be contained in a single column, extend it over both columns, preferable at the top or bottom of a page.

Table 1: Number N of abstracts submitted and number M of submitting countries.

|  |  |  |
| --- | --- | --- |
| **Region** | **N** | **M** |
| Americas | 212 | 3 |
| Asia/Oceania | 250 | 9 |
| Europe/Africa | 166 | 20 |
| **Total** | **628** | **32** |

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-1 ≈*ei*22 7 (1)

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ACKNOWLEDGEMENTS

Nice words and appreciation to someone for something they’ve done to assist you with your paper.

REFERENCES

[1] S. Senturia, “Perspectives on MEMS Past and Future: the Tortuous Pathway from Bright Ideas to Real Products”, in *Digest Tech. Papers Transducers‘03 Conference*, Boston, June 8-12, 2003, pp. 10-15.

[2] T. Tsuchiya, O. Tabata, J. Sakata, Y. Taga, “Specimen Size Effect on Tensile Strength of Surface Micromachined Polycrystalline Silicon Thin Films”, *J. Microelectromech. Syst.*, vol. 7, pp. 106-113, 1998.

[3] R. P. Feynman, *Lectures on Physics*, Addison Wesley, 1989.

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